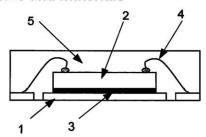


## Package: VQFN×××V6060/7070/8080 series

#### < A table of contents >

1.Structure and materials	1 / 4 page
2.Tape and Reel informations	1/4~3/4 page
3.Storage conditions	3 / 4 page
4.Marking lot number	-3 / 4 page
5. Footprint dimensions	
6.Recommended soldering	4 / 4 page

#### 1.Structure and materials



No. Item Materials

Cu-Alloy
(External lead : Pb free solder plating)

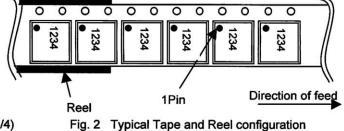
Die Silicon
Die Attach Ag Paste
Wire Cu
Molding Epoxy Resin

Fig. 1 Structure

#### 2. Tape and Reel information

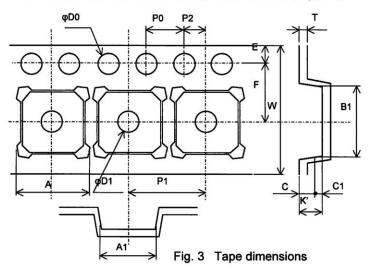
2.1.Packing specification

Таре	Embossed carrier tape
Quantity	See the table on page 4/4
Direction of feed	E2(See Fig. 2)



2.2.Tape and Reel specification

2.2.1. Tape and reel dimensions (See the table on page 4/4)



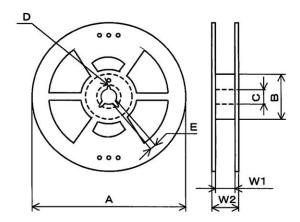


Fig. 4 Reel dimensions

#### 2.3.Leader and Trailer

#### 2.3.1.Leader

No component pockets are 25 pockets or more.

#### 2.3.2.Trailer

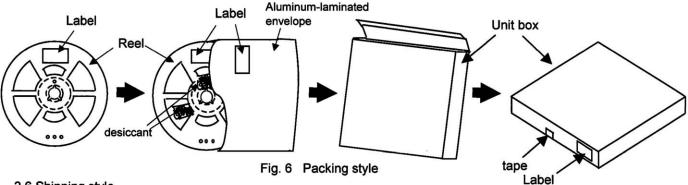
No component pockets are 10 pockets or more.

Tape is free from reel.

# 2.4.Label for Reel and Box Out going inspection Product No. BA1 234 MUV — E2 Quantity 2, 000pcs. 0124 A5110F EN PHILLIPINES ROHIII SCANGER FOR STANK Internal product code Out going inspection BA1 234 MUV — E2 MNo. 124 023 pos. MNo. 124 024 pos. MNo. 124 024 pos. MNo. 124 024 pos. Marking lot number Pb Free Mark Internal product code

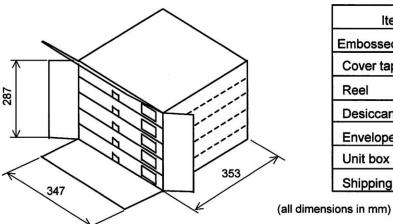
2.5.Packing style

Fig. 5 Label example



#### 2.6. Shipping style

5 unit boxes or less per shipping box



#### 2.7.Packing materials

Item	Material					
Embossed carrier tape	PS					
Cover tape	PET + PE					
Reel	PS					
Desiccant	Silicagel					
Envelope	Aluminume-laminated					
Unit box	Cardboard					
Shipping box	Cardboard					

Fig. 7 Shipping box dimensions and Shipping style

Peelback

#### 2.8.Others

2.8.1.Peelback strength

Cover tape peelback strength is 0.2~0.7N.



#### 2.8.8.Missing ICs

(1)No consecutive dropouts.

(2)A maximun 0.1% of specified number of products in each packing may be missing.

#### 3. Storage conditions

#### 3.1.Storage environment

Recommended storage conditions are as follows:

-Temperature :5to30°C -Humidityzz :40to70 RH

#### 3.2.Storage period

-Specified storage period :1year

#### 3.3. Specified storage period until soldering

Dry process before mounting is necessary in the following two case.

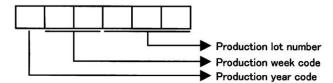
- 1. After the package is opened, the product is left unused over 168 hours.
- 2. Before the package is opened, the product is left in the package unused over 1 year.

Please excute dry processing in a reel state with 60°C for 72 hours.

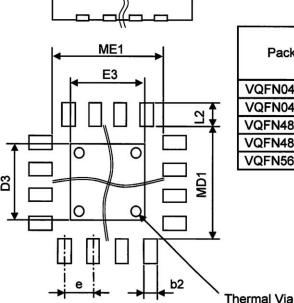
At this time, peelback strength of cover tape become 0.2N -0.9N.

Case of transferring to heatproof container such as trays, excute dry processing with 125°C for 24 hours. In addition, the dry processing should be max, 2 times due to influence on the product's solderability.

#### 4.Marking lot number



#### 5.Footprint dimensions (Optimize footprint dimensions to the board design and soldering condition)



(all dimensions in mm)

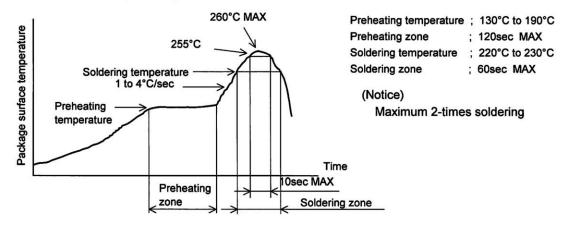
Land nitch	Land						
Land pitch	spa	ace	length	width			
е	MD1	ME1	L2	b 2			
0.50	5.00	5.00	0.80	0.27			
0.50	6.00	6.00	0.80	0.27			
0.50	6.00	6.00	0.80	0.27			
0.50	6.00	6.00	0.80	0.27			
0.50	7.00	7.00	0.80	0.27			
	0.50 0.50 0.50 0.50	e MD1 0.50 5.00 0.50 6.00 0.50 6.00 0.50 6.00	e MD1 ME1  0.50 5.00 5.00  0.50 6.00 6.00  0.50 6.00 6.00  0.50 6.00 6.00	Land pitch         space         length           e         MD1         ME1         L2           0.50         5.00         5.00         0.80           0.50         6.00         6.00         0.80           0.50         6.00         6.00         0.80           0.50         6.00         6.00         0.80			

	Radiation	on land	Thermal Via			
Package	length	width				
	D3	E3	Pitch	Diameter		
VQFN040V6060	4.00	4.00	1.2	φ0.300		
VQFN048V7070	5.00	5.00	1.2	φ0.300		
VQFN48AV7070	3.50	3.50	1.2	φ0.300		
VQFN48SV7070	3.50	3.50	1.2	φ0.300		
VQFN56AV8080	3.70	3.70	1.2	φ0.300		

<sup>\*</sup>The lead toe and lead side fillet may not be achieved because of non-lead packages.

#### 6. Soldering conditions

#### 6.1.Recommended temperature profile for reflow



6.2. The wave soldering method is not supported.

#### (Tape dimensions)

Package	Quantity		Tape dimensions (all dimensions in mm)												
rackage	(pcs)	A1	B1	C	C1	D0	D1	E	F	K'	P0	P1	P2	Т	W
VQFN040V6060	2000	6.2	6.2	(1.15)	(0.65)	φ1.5	φ1.5	1.75	5.5	1.80	4.0	8.0	2.0	0.3	12.0
VQFN048V7070	1500	7.2	7.2	(1.15)	(0.65)	φ1.5	φ1.5	1.75	7.5	1.80	4.0	12.0	2.0	0.3	16.0
VQFN48AV7070	1500	7.2	7.2	(1.15)	(0.65)	φ1.5	φ1.5	1.75	7.5	1.80	4.0	12.0	2.0	0.3	16.0
VQFN48SV7070	1500	7.2	7.2	(1.15)	(0.65)	φ1.5	φ1.5	1.75	7.5	1.80	4.0	12.0	2.0	0.3	16.0
VQFN56AV8080	1000	8.2	8.2	(1.15)	(0.65)	φ1.5	φ1.5	1.75	7.5	1.80	4.0	12.0	2.0	0.3	16.0
Tolerano	е	±0.05	±0.05			+0.1/0	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.05	±0.3

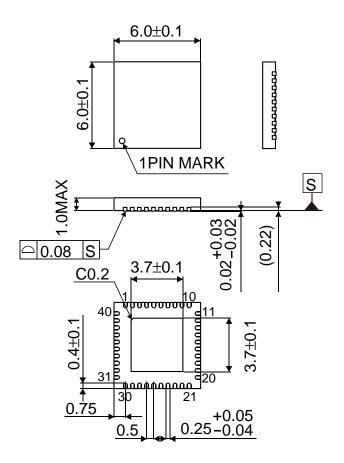
4/4

#### (Reel dimensions)

Package	Reel dimensions (all dimensions in mm)							Dehydrated weight	
rackage	Α	В	С	D	E	W1	W2	(g)	
VQFN040V6060	φ330	φ60	φ13.0	φ20.2	1.5	13.4	17.4	0.094	
VQFN048V7070	φ330	φ60	φ13.0	φ20.2	1.5	17.4	21.4	0.130	
VQFN48AV7070	φ330	φ60	φ13.0	φ20.2	1.5	17.4	21.4	0.130	
VQFN48SV7070	φ330	φ60	φ13.0	φ20.2	1.5	17.4	21.4	0.130	
VQFN56AV8080	φ330	φ80	φ13.0	φ20.2	1.5	17.4	21.4	0.141	
Tolerance	•	+1.0/0	±0.2	MIN	MIN	+1.0/0	±1.0		

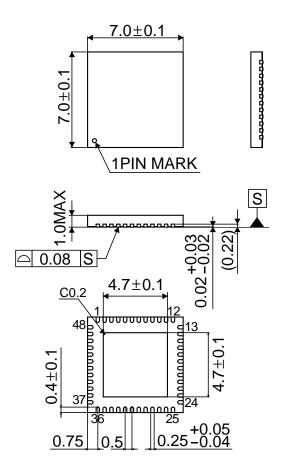


## **VQFN040V6060**



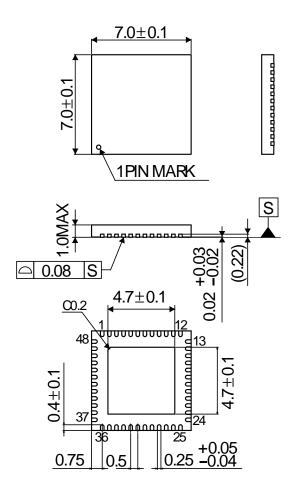


## VQFN048V7070



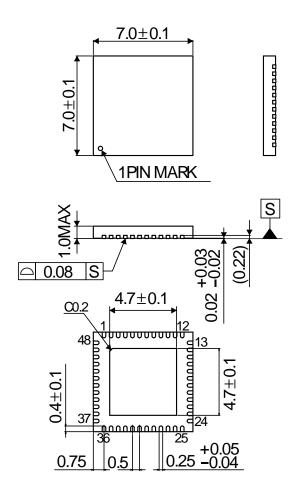


VQFN48AV7070



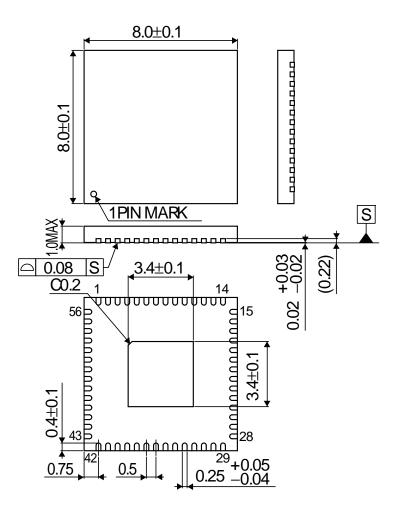


VQFN48SV7070





VQFN56AV8080



#### Notes

No copying or reproduction of this document, in part or in whole, is permitted without the consent of ROHM Co.,Ltd.

The content specified herein is subject to change for improvement without notice.

The content specified herein is for the purpose of introducing ROHM's products (hereinafter "Products"). If you wish to use any such Product, please be sure to refer to the specifications, which can be obtained from ROHM upon request.

Examples of application circuits, circuit constants and any other information contained herein illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.

Great care was taken in ensuring the accuracy of the information specified in this document. However, should you incur any damage arising from any inaccuracy or misprint of such information, ROHM shall bear no responsibility for such damage.

The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM and other parties. ROHM shall bear no responsibility whatsoever for any dispute arising from the use of such technical information.

The Products specified in this document are intended to be used with general-use electronic equipment or devices (such as audio visual equipment, office-automation equipment, communication devices, electronic appliances and amusement devices).

The Products specified in this document are not designed to be radiation tolerant.

While ROHM always makes efforts to enhance the quality and reliability of its Products, a Product may fail or malfunction for a variety of reasons.

Please be sure to implement in your equipment using the Products safety measures to guard against the possibility of physical injury, fire or any other damage caused in the event of the failure of any Product, such as derating, redundancy, fire control and fail-safe designs. ROHM shall bear no responsibility whatsoever for your use of any Product outside of the prescribed scope or not in accordance with the instruction manual.

The Products are not designed or manufactured to be used with any equipment, device or system which requires an extremely high level of reliability the failure or malfunction of which may result in a direct threat to human life or create a risk of human injury (such as a medical instrument, transportation equipment, aerospace machinery, nuclear-reactor controller, fuel-controller or other safety device). ROHM shall bear no responsibility in any way for use of any of the Products for the above special purposes. If a Product is intended to be used for any such special purpose, please contact a ROHM sales representative before purchasing.

If you intend to export or ship overseas any Product or technology specified herein that may be controlled under the Foreign Exchange and the Foreign Trade Law, you will be required to obtain a license or permit under the Law.



Thank you for your accessing to ROHM product informations.

More detail product informations and catalogs are available, please contact us.

## ROHM Customer Support System

http://www.rohm.com/contact/